



Silicone Materials for Electronic Devices and Component Assemblies



Contents

Overview.....1-2

Industry Overview3-4

Product Index

Adhesives and Sealants.....5-6

Grease.....7

Coating Materials.....7-8

Encapsulants / Potting Materials.....9-10

Selection Guide.....11-12

Product Details

1 Part Condensation Cure.....13-17

1 Part Heat (Addition) Cure18-20

2 Part Room Temperature. Cure21-22

2 Part Heat (Addition) Cure.....23-24

1 Part & 2 Part Gels25-26

Junction Coating Resin (JCR) Grades.....27

Grease.....28

UL Certifications.....29-30

Technical Information.....31-32

FAQ.....33

Silicone Product Profile

The products introduced in this selector guide consist of RTV (Room Temperature Vulcanizing) silicone products that are commonly found in Electric and Electronic applications and component assemblies. This family of silicone products consists of both **Room Temperature Cure** and **Heat (Addition) Cure** grades.

Momentive Performance Materials offers a comprehensive portfolio of silicone solutions to help meet a broad array of handling and performance needs in electronic components and assemblies. Selection of the appropriate type of RTV depends upon the required manufacturing process, handling requirements, curing

conditions, equipment, and desired material properties.

Condensation Cure

Condensation cure silicone products cure when exposed to moisture in the environment at room temperature. These materials are categorized into Alkoxy, Acetoxy, or Oxime based on the byproducts that occur during cure.

Heat (Addition) Cure

Heat cure grades cure upon exposure to elevated heat or room temperature.

Sealing & Adhesion

Silicones are used in a wide array of applications for bonding components, and sealing against moisture or environmental contaminants. A comprehensive portfolio of 1 Part and 2 Part Adhesives and Sealants, many of which are excellent candidates for assembly applications on or near sensitive electrical and electronic components, are available. These materials are applied by a variety of methods ranging from manual dispensing to auto-dispensing units for tube, cartridge, pail, or drum packages. Mixing for 2 Part grades may be accomplished by either manual processes

or meter mix dispensing, depending on production volume and post-mix material properties.

Performance Considerations

- Temperature Resistance
- Dielectric Resistance
- Flame Retardancy
- Low Volatility
- Adhesion
- Mechanical Strength
- Hardness
- Thermal Conductivity

Process Considerations

- Viscosity
- Cure Mechanism
- Cure Temperature
- Cure Time
- Pot Life

Coating

The Coating process involves the application of silicone in a thin protective layer to a component surface by methods such as dip, flow, spray, and selective robotic



Performance Considerations

- Temperature Resistance
- Dielectric Resistance
- Flame Retardancy
- Low Volatility
- Stress Relief

Process Considerations

- Viscosity
- Cure Mechanism
- Cure Temperature
- Cure Time
- Pot Life

Potting & Encapsulation

Silicone rubber and gels are widely used in electronics to ensure mechanical and environmental protection. A full range of products are offered in various cure speeds, viscosities, and

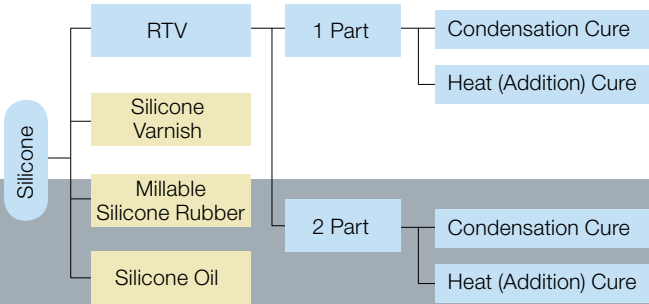


Performance Considerations

- Temperature Resistance
- Dielectric Resistance
- Flame Retardancy
- Low Volatility
- Adhesion
- Stress Relief
- Release Properties
- Thermal Conductivity

Process Considerations

- Viscosity
- Cure Mechanism
- Cure Temperature
- Cure Time
- Pot Life



Relative Performance Characteristics

Property	Silicone RTV	Epoxy	Urethane
Temperature Range	-50 ~ +200 °C	-50 ~ +150 °C	-30 ~ +120 °C
Heat Resistance	Good	Poor	Poor
Flame Retardancy ¹	Good	None	None
UV Stability	Good	Poor	Poor
Ozone Stability	Good	Poor	Poor
Modulus	Low	High	High

¹As a base material silicone demonstrates flame retardant properties comparable to UL94HB.



Industries Served

Electronic Devices and Power Modules

Momentive Performance Materials is a driving force as a supplier of advanced silicone technology to the electronics industry. Increasing electronic component densities and performance demands have created a need for specialized silicone solutions from Momentive for a broad mix of performance and handling requirements.

Typical Applications:

- Power converters
- Inverters
- Hybrid ICs
- Micro-Electronic packaging
- High-voltage component insulation
- Membrane switches
- Photo couplers



Board Assembly

Silicones are found in board-level adhesion, coating, and encapsulation applications, and contribute to the long-term, reliable performance of many components and assemblies. A wide portfolio of products is available, providing flame retardancy, thermal conductivity, temperature resistance, low-volatility, or high-purity benefits.

Typical Applications:

- Board-level adhesion, fixing, and sealing
- PCB coating
- Component encapsulation
- Junction Coating Resins

Consumer Electronics

Silicones are commonly used in a variety of consumer electronics applications. In addition to providing adhesion to many substrates, an array of grades are available to provide heat resistance, flame retardancy, low volatility for sensitive components, and moisture protection.

Typical Applications:

- Flat panel displays
- PCs and Smart Phones
- LED Lighting
- Steam iron plate seals
- Air conditioner units
- Control panel insulation
- PCB fixing and sealing



Automotive Electronics

The automotive industry plays a critical role in integrating new electronic technologies. As more and more components migrate to electronic solutions, silicones play an increasingly important role in helping deliver material solutions that contribute to design flexibility and long-term component reliability under harsh



Typical Applications:

- ECU potting, sealing, coating
- Wire connector sealing
- Sealing, encapsulation in a broad range of sensors
- HVAC system sealing
- Vibration dampening
- Headlamp assemblies

Aviation and Aerospace

Avionics and frame assembly needs in Aviation and Aerospace are served through silicone adhesives, coating, encapsulation and potting materials that help withstand stress and temperature extremes.

Typical Applications:

- Avionics
- Circuit and terminal protection
- Wire sealants
- Engine gasketing
- Cargo door, window sealing
- Weatherstrip adhesives
- Aviation lighting
- Ventilation ducts



Energy

Reliability of electronic components and the ability for panels to withstand harsh conditions over the lifecycle of the product are important considerations in solar energy applications. Momentive Performance Materials helps serve this growing industry with its range of potting materials

and sealants.

Typical Applications:

- Terminal box potting
- Box and base sealing
- Aluminum frame and glass / EVA plate sealing



Product Overview: Adhesives & Sealants

						Performance								Product Detail
Type	Grade	Cure Chemistry	Cured Property	Feature		Flowability	Flame Retardancy	Low Volatility	Thermally Conductive	High Temp. Resistance	Low Temp. Resistance	FDA Compliant	MIL-Spec	
1 Part Condensation Cure	RTV133	Alkoxy	Rubber	UL certified non-flowable sealant.		Non-flowable	UL94 V-0							P. 13
	RTV167	Alkoxy	Rubber	High-strength paste adhesive with UL certified and Mil Spec.		Non-flowable	UL94 HB						MIL-A-46146B	P. 13
	TSE385	Alkoxy	Rubber	Paste adhesive. Suitable for PC substrates.		Non-flowable								P. 13
	TSE3853-W	Alkoxy	Rubber	UL certified, semi-flowable paste.		Semi-flowable	UL94 V-0							P. 14
	TSE3854DS	Alkoxy	Rubber	UL certified paste adhesive.		Non-flowable	UL94 V-0							P. 13
	TN3005	Alkoxy	Rubber	Fast tack, low volatile paste paste adhesive.		Non-flowable		●						P. 13
	TN3085	Alkoxy	Rubber	Fast tack, low volatile paste paste adhesive. UL certified		Non-flowable	UL94 V-0	●	●					P. 13
	TSE3941M	Alkoxy	Rubber	Fast tack, thermally conductive flowable sealant.		Flowable			●					P. 14
	TSE3944	Alkoxy	Rubber	Low volatile, UL certified flowable sealant.		Semi-flowable	UL94 V-0	●						P. 14
	TN3305	Alkoxy	Rubber	Fast tack, low volatile flowable adhesive / sealant		Flowable		●						P. 14
	TSE3971	Alkoxy	Rubber	Flowable adhesive / sealant.		Flowable								P. 14
	TSE3976-B	Alkoxy	Rubber	Low volatile, temperature resistant sealant. UL certified.		Flowable	UL94 HB	●		●				P. 14
	XE11-B5320	Alkoxy	Rubber	Fast tack, low volatile, thermally conductive adhesive. UL certified.		Non-flowable	UL94 HB	●	●					P. 13
	FRV1106	Acetoxo	Rubber	Fuel, solvent, chemical, and temperature-resistant fluoro sealant.		Non-flowable				●				P. 16
	RTV100 series	Acetoxo	Rubber	FDA, USDA, and NSF compliant paste adhesive. Mil Spec.		Non-flowable						●	MIL-A-46106B	P. 17
	RTV106	Acetoxo	Rubber	Temperature-resistant adhesive. FDA, USDA, & NSF compliant. Mil Spec.		Non-flowable				●		●	MIL-A-46106B	P. 17
	RTV116	Acetoxo	Rubber	Temperature-resistant flowable sealant. FDA, USDA, & NSF compliant. Mil Spec.		Flowable				●		●	MIL-A-46106B	P. 17
	RTV157	Acetoxo	Rubber	High strength paste / adhesive.		Non-flowable								P. 17
	RTV159	Acetoxo	Rubber	High strength paste / adhesive. Temperature-resistant.		Non-flowable				●				P. 17
	TSE370	Acetoxo	Rubber	Fast tack, general purpose paste adhesive.		Non-flowable								P. 17
	TSE382	Oxime	Rubber	Fast tack, general purpose adhesive paste. UL certified.		Non-flowable	UL94 HB							P. 15
	TSE3826	Oxime	Rubber	Fast tack adhesive for high-temperature applications.		Non-flowable				●				P. 16
	TSE3840-G	Oxime	Rubber	UL certified general purpose adhesive / sealant.		Semi-flowable	UL94 V-0							P. 16
	TSE3843-W	Oxime	Rubber	UL certified general purpose adhesive / sealant.		Semi-flowable	UL94 V-1		●					P. 16
	TSE384-B	Oxime	Rubber	UL certified general purpose adhesive / sealant.		Non-flowable	UL94 V-0							P. 16
	TSE387	Oxime	Rubber	General purpose flowable adhesive / sealant.		Flowable								P. 16
	TSE3877-B	Oxime	Rubber	Flowable sealant for high-temperature applications.		Flowable				●				P. 16
	TSE388	Oxime	Rubber	Flowable general purpose adhesive / sealant.		Flowable								P. 16
1 Part Heat Cure	TSE3212	Heat	Rubber	Thixotropic adhesive / sealant.		Semi-flowable								P. 18
	TSE322	Heat	Rubber	Flowable adhesive / sealant.		Flowable								P. 18
	TSE3221S	Heat	Rubber	Flowable adhesive / sealant.		Flowable								P. 19
	TSE322S	Heat	Rubber	UL certified, semi-flowable adhesive / sealant.		Semi-flowable	UL94 HB							P. 18
	TSE326	Heat	Rubber	UL certified, high temperature-resistant adhesive / sealant.		Flowable	UL94 HB			●				P. 19
	TSE3261-G	Heat	Rubber	High temperature-resistant adhesive / sealant.		Flowable				●				P. 18
	TSE326M ¹	Heat	Rubber	High temperature-resistant adhesive / sealant.		Flowable				●				P. 19
	TSE3280-G	Heat	Rubber	Thermally conductive adhesive.		Flowable			●					P. 18
	TSE3281-G	Heat	Rubber	Thermally conductive adhesive.		Flowable			●					P. 19
2P RT Heat Cure	XE13-B3208	Heat	Rubber	General purpose adhesive / sealant.		Non-flowable								P. 18
	RTV577	Condensation	Rubber	Extreme low temperature resistant sealant. Release capability.		Non-flowable					●			P. 21
	RTV88	Condensation	Rubber	Semi-flowable temperature-resistant sealant. Release capability.		Semi-flowable				●				P. 21
	TSE3360	Heat	Rubber	General purpose adhesive / sealant.		Non-flowable								P. 23
	TSE3380	Heat	Rubber	Thermally conductive adhesive. Fast cure at elevated temperatures.		Flowable			●					P. 23
	XE14-A0425	Heat	Rubber	Heat resistant, thermally conductive adhesive.		Semi-flowable			●	●				P. 23

¹ TSE326M-EX in Europe and the Americas

Product Overview: Coating Materials

						Performance								Product Detail
Type	Grade	Cure Chemistry	Cured Property	Feature		Flowability	Flame Retardancy	Low Volatility	Thermally Conductive	High Temp. Resistance	JCR Grade	FDA Compliant	MIL-Spec	
1 Part Condensation Cure	ECC3010	Alkoxy	Rubber	Fast cure conformal coating material. Solvent free		Flowable								P. 15
	ECC3050S	Alkoxy	Rubber	Fast cure conformal coating material. Low volatile. Solvent free		Flowable		●						P. 15
	ECS0600	Alkoxy	Rubber	High purity repairable electrode coating. Fast tack.		Flowable		●						P. 15
	ECS0601	Alkoxy	Rubber	High purity, non-repairable type electrode coating. UL certified.		Flowable	UL94 HB	●						P. 15
	ECS0609FR	Alkoxy	Rubber	High purity, non-repairable type electrode coating. UL certified.		Flowable	UL94 V-0	●						P. 14
	RTV160	Alkoxy	Rubber	UL certified flowable sealant.		Flowable	UL94 HB							P. 14
	TSE3941M	Alkoxy	Rubber	Fast tack, thermally conductive flowable sealant.		Flowable			●					P. 14
	TSE3944	Alkoxy	Rubber	Low volatile, UL certified flowable sealant.		Semi-flowable	UL94 V-0	●						P. 14
	TN3305	Alkoxy	Rubber	Fast tack, low volatile flowable adhesive / sealant		Flowable		●						P. 14
	TSE3971	Alkoxy	Rubber	Flowable sealant.		Flowable								P. 14
	TSE3976-B	Alkoxy	Rubber	Low volatile, temperature resistant sealant. UL certified.		Flowable	UL94 HB	●		●				P. 14
	TSE398	Alkoxy	Rubber	Pourable coating / encapsulant.		Flowable								P. 15
	TN3705	Alkoxy	Rubber	Low volatile, low viscosity coating / potting material		Flowable		●						P. 15
	XE11-A5133S	Alkoxy	Rubber	Low volatile, UL certified, thermally conductive coating & potting.		Flowable	UL94 V-1	●	●					P. 14
	RTV110 series	Acetoxo	Rubber	General purpose coating / encapsulant. FDA, USDA, and NSF compliant. Mil Spec.		Flowable						●	MIL-A-46106B	P. 17
	TSE387	Oxime	Rubber	General purpose flowable sealant / coating.		Flowable								P. 16
	TSE3877-B	Oxime	Rubber	Flowable sealant for high-temperature applications.		Flowable				●				P. 16
	TSE388	Oxime	Rubber	Flowable, general purpose sealant / coating.		Flowable								P. 16
	TSE389	Oxime	Rubber	Flowable, UL certified coating / sealant.		Flowable	UL94 HB							P. 16
1 Part Heat Cure	ECC4865	Heat	Rubber	Extreme low viscosity coating material with UV tracer.		Flowable								P. 20
	TSE3221S	Heat	Rubber	Flowable sealant / coating material.		Flowable								P. 19
	TSE325	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSE3250	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSE3251	Heat	Rubber	Flowable coating material.		Semi-flowable								P. 20
	TSE3251-C	Heat	Rubber	Flowable coating material.		Semi-flowable								P. 20
	TSE325-B	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSJ3155	Heat	Rubber	High purity JCR-grade white rubber.		Semi-flowable					●			P. 27
	TSJ3195-W	Heat	Gel	High purity JCR-grade white gel.		Semi-flowable					●			P. 27
	TSJ3185	Heat	Gel	High purity JCR-grade translucent gel.		Semi-flowable					●			P. 27
2P RT	RTV11	Condensation	Rubber	General purpose encapsulation and potting. FDA compliant.		Flowable						●		P. 22
2 Part Heat Cure	TSE3033	Heat	Rubber	Transparent coating / encapsulant. Fast cure at elevated temperatures.		Flowable								P. 24
	TSE3331	Heat	Rubber	UL certified, thermally conductive, coating / encapsulant.		Flowable	UL94 V-0		●					P. 23
	TSE3331K ¹	Heat	Rubber	Low viscosity variant of TSE3331.		Flowable	UL94 V-0		●					P. 24
	TSE3331K EX ¹	Heat	Rubber	Low viscosity variant of TSE3331.		Flowable	UL94 V-0		●					P. 23
	XE14-B5778	Heat	Rubber	High purity JCR-grade translucent rubber.		Semi-flowable					●			P. 27
	TSJ3175	Heat	Gel	High purity JCR-grade thixotropic gel.		Semi-flowable					●			P. 27

¹ TSE3331K for Asia Pacific, TSE3331K EX for Europe and the Americas

Grease - Product Index

		Performance				Product Detail
Grade	Feature	Thermally Conductive	Low Bleed	Low Volatility	Heat Resistant	
TSK5303	Moderate thermal conductivity with heat resistance.	●		●	●	P. 28
TSK5370	General electrical insulation. Swell resistant on silicone.			●		P. 28
TSK550	General electrical insulation, arc resistance.					P. 28
TSK551	Insulator protection from salt, dust.					P. 28
YG6111	Moderate thermal conductivity.	●		●		P. 28
YG6240	Moderate thermal conductivity, low-bleed performance.	●	●	●		P. 28
YG6260	Moderate thermal conductivity.	●		●		P. 28
TIG1000	High thermal conductivity.	●		●		P. 28

Product Overview: Encapsulants and Potting Materials

						Performance								Product Detail
Type	Grade	Cure Chemistry	Cured Property	Feature		Flowability	Flame Retardancy	Low Volatility	Thermally Conductive	High Temp. Resistance	Low Temp. Resistance	FDA Compliant	MIL-Spec	
1 Part Cond. Cure	RTV160	Alkoxy	Rubber	UL certified flowable encapsulant.		Flowable	UL94 HB							P. 14
	TSE398	Alkoxy	Rubber	Pourable coating / encapsulant.		Flowable								P. 15
	TN3705	Alkoxy	Rubber	Low volatile, low viscosity potting / coating material.		Flowable		●						P. 15
	XE11-A5133S	Alkoxy	Rubber	Low volatile, UL certified, thermally conductive coating & potting.		Flowable	UL94 V-1	●	●					P. 14
	RTV110 series	Acetoxo	Rubber	General purpose coating / encapsulant. FDA, USDA, and NSF compliant. Mil Spec.		Flowable						●	MIL-A-46106B	P. 17
	RTV116	Acetoxo	Rubber	Temperature-resistant flowable sealant. FDA, USDA, and NSF compliant. Mil Spec.		Flowable				●		●	MIL-A-46106B	P. 17
1 Part Heat Cure	TSE325	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSE3250	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSE325-B	Heat	Rubber	Flowable coating / encapsulant.		Flowable								P. 20
	TSE3051	Heat	Gel	Low viscosity potting gel.		Flowable								P. 25
	TSE3051-FR	Heat	Gel	UL certified variant of TSE3051.		Flowable	UL94 V-1							P. 25
	TSE3051-L	Heat	Gel	Low penetration variant of TSE3051.		Flowable								P. 25
2 Part Room Temp. Cure	TSE3053	Heat	Gel	High penetration gel.		Flowable								P. 25
	RTV11	Condensation	Rubber	General purpose encapsulation and potting. FDA compliant.		Flowable						●		P. 22
	RTV31	Condensation	Rubber	High temperature resistant potting. Good release properties.		Flowable				●				P. 22
	RTV566	Condensation	Rubber	Low volatile, high-low temperature-resistance.		Flowable		●		●	●			P. 21
	RTV60	Condensation	Rubber	Extreme high temperature-resistant coating / potting. Release capability.		Flowable				●				P. 21
	TSE3663	Condensation	Rubber	Flowable encapsulant / potting material.		Flowable								P. 22
2 Part Heat Cure	TSE3661	Condensation	Rubber	Flowable encapsulant / potting material.		Flowable	UL94 HB							P. 22
	TSE3664K	Condensation	Rubber	UL certified, flowable encapsulant / potting material.		Flowable	UL94 V-0							P. 22
	RTV615	Heat	Rubber	High strength potting material. Fast cure at elevated temperatures.		Flowable						●		P. 23
	TSE3032	Heat	Rubber	Transparent potting / encapsulant with excellent release properties.		Flowable								P. 23
	TSE3033	Heat	Rubber	Low viscosity, transparent potting material. Fast cure at elevated temperatures.		Flowable								P. 24
	TSE3331	Heat	Rubber	UL certified, thermally conductive, coating / encapsulant.		Flowable	UL94 V-0		●					P. 23
	TSE3331K ¹	Heat	Rubber	Low viscosity variant of TSE3331.		Flowable	UL94 V-0		●					P. 24
	TSE3331K EX ¹	Heat	Rubber	Low viscosity variant of TSE3331.		Flowable	UL94 V-0		●					P. 23
	TSE3431	Heat	Rubber	UL certified, thermally conductive potting material. Release capability.		Flowable	UL94 V-0		●					P. 24
	TSE3431-H	Heat	Rubber	UL certified, thermally conductive potting material. Release capability.		Flowable	UL94 V-0		●					P. 24
	XE14-B7892	Heat	Rubber	UL certified low-viscosity potting material. Low temperture cure. Release capability.		Flowable	UL94 V-0							P. 24
	YE5822	Heat	Rubber	Low viscosity potting material. Good release properties.		Flowable								P. 24
	RTV6136-D1	Heat	Gel	Low viscosity potting gel with fast cure at low temperatures.		Flowable								P. 26
	TSE3062	Heat	Gel	Fast cure at low temperatures.		Flowable								P. 26
	TSE3070	Heat	Gel	High-elongation gel with low temperature cure.		Flowable								P. 26

¹ TSE3331K for Asia Pacific, TSE3331K EX for Europe and the Americas

Selection Guide

1 Part Grades

BLACK=Rubber RED=Gels Alkoxy Acetoxy Oxime Heat

Viscosity Range	Performance					
	Thermally Conductive	Low Volatility	UL Certified	Temp. Resistant	FDA Compliant	General Purpose
Non-Flowable	TN3085 XE11-B5320	TN3005 TN3085 XE11-B5320	TSE3854DS TN3085 RTV133			TSE385
				FRV1106 RTV106	RTV100 RTV106	RTV157 TSE370
			TSE382 TSE384-B	TSE3826		
						XE13-B3208
High Viscosity		TSE3976-B	TSE3853-W TSE3976-B	TSE3976-B		TSE3971
				RTV159		
	TSE3843-W		TSE3840-G TSE3843-W	TSE3877-B		
Medium Viscosity						TSE3212 TSE322
	TSE3941M XE11-A5133S	TSE3944 XE11-A5133S TN3305	TSE3944 XE11-A5133S RTV160 RTV167 RTV110	RTV116	RTV110 RTV116	
						TSE387 TSE388
Low Viscosity						TSE3221S
	TSE3280-G TSE3281-G		TSE322S TSE325	TSE326 TSE3261-G TSE326M		
Low Viscosity		ECC3050S ECS0600 ECS0601 ECS0609FR TN3705	ECS0601 ECS0609FR			ECC3010
			TSE389 TSE3051FR			
						TSE3051 TSE3051-L TSE3053 TSE325 TSE3250 TSE3251 TSE3251-C TSE325-B

Cure System Performance Guide

Attribute	Alkoxy		Acetoxy	Oxime	Heat Cure
	Fast Cure	Slow Cure			
Cure Byproduct	Alcohol	Alcohol	Acetic Acid	Methylethyl Ketoxime	None
Cure Speed	Fast	Slow	Fast	Moderate	Very Fast
Corrosion on Copper	None	None	Yes	Yes	None
Corrosion on Metals	None	None	Yes	None	None
Odor	Low	Low	Strong	Low	None
Strength	Good	Good	Very Strong	Good	Good

2 Part Grades

BLACK=Rubber RED=Gels Heat Room Temperature

Viscosity Range	Performance					
	Thermally Conductive	Low Volatility	UL Certified	Temp. Resistant	FDA Compliant	General Purpose
Non-Flowable						TSE3360
High Viscosity				XE14-A0425		TSE3971
	XE14-A0425			RTV577 RTV88		
Medium Viscosity	TSE3380					
		RTV566		RTV31 RTV566 RTV60	RTV11	
Low Viscosity	TSE3331 TSE3331K TSE3431 TSE3431-H		TSE3331 TSE3331K TSE3431 TSE3431-H XE14-B7892		RTV615	RTV6136-D1 TSE3032 TSE3033 TSE3062 TSE3070 TSE3330 YE5822
	TSE3661 TSE3664K	RTV567	RTV567 TSE3664K			TSE3663



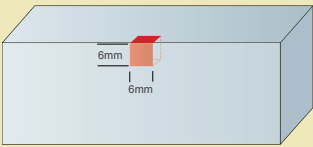
Viscosity and flowability of the silicone material are often key factors in the selection of a material for use in sealing, coating, and encapsulation / potting applications. A broad array of material performance and viscosity combinations are provided to help match the requirements of many applications.

Application Geometry and Cure Chemistry Options

The shape and conditions of the part are important in selecting the suitable silicone grade for each application.

The following are some general guidelines:

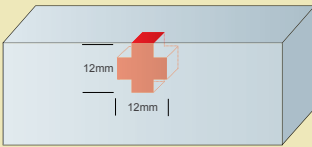
Shallow Cavity / Small Mass



Selection Options:

- 1 Part Condensation Cure
- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

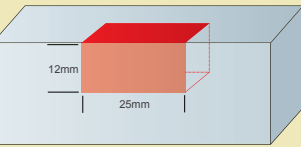
Complex Design - Exposed Surface



Selection Options:

- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

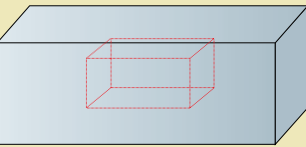
Deep Cavity / Large Mass



Selection Options:

- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

Enclosed System



Selection Options:

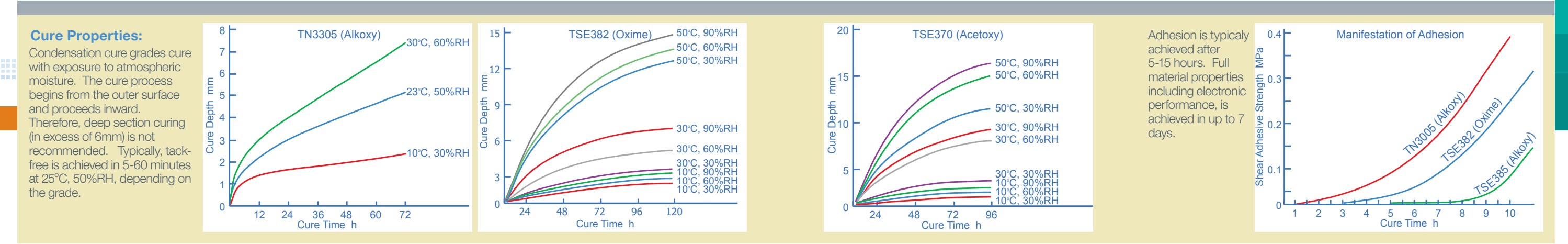
- 1 Part Heat Cure
- 2 Part Heat Cure

Product Details - 1 Part Condensation Cure Grades

Properties		RTV167	RTV133	TSE385	TSE3854DS	TN3005	TN3085	XE11-B5320		TSE3944	TSE3853-W	TSE3971	TSE3976-B	XE11-A5133S	TSE3941M	TN3305	RTV160	ECS0609FR
Cure Chemistry		Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy		Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy
Flowability		Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable		Semi-Flowable	Semi-Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable
Features and Benefits		High strength, paste adhesive with MILA-46106B and UL certified	UL certified paste adhesive.	Paste adhesive	Paste adhesive. UL certified	Fast tack, low volatile paste adhesive.	Fast tack, low volatile paste adhesive. UL certified	Fast tack, low volatile, thermally conductive paste adhesive.		Flowable low volatile adhesive / sealant. UL certified	Flowable adhesive / sealant. UL certified	Flowable adhesive / sealant.	Flowable, high-temperature resistant low volatile adhesive / sealant. UL certified	Flowable, low volatile thermally conductive potting / coating material. UL certified	Fast tack, thermally conductive flowable adhesive / sealant.	Fast tack, flowable adhesive / sealant.	Flowable adhesive with UL certified	High-purity electrode coating material with fast tack performance. UL certified
Application	Adhesive / Sealant	●	●	●	●	●	●	●		●	●	●	●		●	●		
	Coating									●		●	●	●	●	●	●	●
	Encapsulant / Potting													●			●	
Viscosity (23°C)		Pa.s (P)	-	-	-	-	-	-		-	400 (4000) ¹	100 (1000) ¹	100 (1000) ¹	60 (600) ¹	50 (500) ¹	47 (470) ¹	38 (380) ²	18 (180) ¹
Application Rate		g/min	180	650	-	-	-	-		-	-	-	-	-	-	-	-	-
Tack Free Time		min	240	60	90	15	7	7		5	15	10	5	10	5	9	240	7
Specific Gravity (23°C)			1.12	1.23	1.10	1.33	1.04	1.63		1.31	1.31	1.04	1.08	1.64	1.64	1.04	1.04	1.22
Hardness			37	46	35	45	22	46		38	34	16	30	63	63	14	25	28
Tensile Strength		MPa (psi)	5.5 (800)	4.5 (650)	2.9 (420)	3.0 (435)	1.8 (260)	2.3 (335)		1.5 (220)	2.3 (335)	1.5 (220)	1.7 (245)	3.9 (565)	3.2 (465)	1.5 (220)	1.9 (275)	2.4 (350)
Elongation		%	600	250	390	300	330	150		170	270	350	210	100	70	400	230	250
Adhesive Strength		MPa (psi)	1.2 (175)	-	2.0 (290)	2.2 (320)	1.2 (175)	1.3 (190)		1.0 (145)	1.3 (190)	1.1 (160)	1.3 (190)	1.3 (190)	1.4 (205)	1.0 (145)	-	1.2 (175)
Thermal Conductivity		W/m-K	-	-	0.17	0.34	0.18	0.7		0.36	0.34	0.18	0.18	0.83	0.83	0.18	-	-
Volume Resistivity		MΩ·m	3.0x10 ⁷	3.0x10 ⁷	5.0x10 ⁷	2.0x10 ⁶	2.0x10 ⁶	4.0x10 ⁷		1.0x10 ⁷	2.0x10 ⁶	2.0x10 ⁷	1.0x10 ⁷	4.0x10 ⁶	4.0x10 ⁶	2.0x10 ⁷	4.0x10 ⁶	1.0x10 ⁵
Dielectric Strength		kV/mm	20	20	22	25	23	22		22	20	21	20	20	21	26	20	20
Dielectric Constant (60Hz)			2.8	2.8 (100Hz)	3.0	3.1	4.0	2.9		3.8	3.1	2.9	3.5	4.0	4.0	2.7	2.8	3.1
Dissipation Factor (60Hz)			0.0026	0.001 (100Hz)	0.001	0.02	0.002	0.04		0.02	0.02	0.005	0.01	0.04	0.04	0.002	0.001	0.05
Low Molecular Siloxane (D ₃ -D ₁₀) wt%			-	-	-	-	0.01	0.01		0.028	-	-	0.025	0.025	-	0.028	-	-
Flame Retardancy			UL94 HB	UL94 V-0		UL94 V-0		UL94 V-0		UL94 V-0	UL94 V-0		UL94 HB	UL94 V-1			UL94 HB	UL94 V-0
Low Volatility						●	●	●		●			●	●		●		●
Temperature Resistance													●					
Thermally Conductive							●	●						●	●			
FDA																		
MIL-Spec ²		MIL-A-46106B ³																
Color	White			●	●	●	●	●		●	●	●		●	●	●	●	
	Clear					●										●		
	Black		●			●						●	●			●		
	Gray	●					●			●								●
Packaging	Tube	●		●	●		●	●		●	●	●	●	●	●			
	Cartridge	●	●	●	●		●			●	●	●	●	●	●		●	●
	Can																	
	Pail														●			
	See Page 15 for details					●										●		

¹JIS K 6249 ²Testing is performed in accordance with current Momentive Performance Materials quality test methods, laboratory conditions, procedures, frequency and sampling. ³MIL-A-46106B Group I Type I

Typical property data values should not be used as specifications



Product Details - 1 Part Condensation Cure Grades

Properties		TSE398	ECS0600	TN3705	ECS0601	ECS3050S	ECC3010	TSE382		TSE3826	TSE384-B	TSE3840-G	TSE3843-W	TSE3877-B	TSE387	TSE388	TSE389	FRV1106
Cure Chemistry		Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Oxime		Oxime	Oxime	Oxime	Oxime	Oxime	Oxime	Oxime	Oxime	Acetoxy
Flowability		Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Non-Flowable		Non-Flowable	Non-Flowable	Semi-Flowable	Semi-Flowable	Flowable	Flowable	Flowable	Flowable	Non-Flowable
Features and Benefits		Flowable adhesive / sealant.	High-purity electrode coating material with fast tack performance. Repairable type	Low volatile potting and coating material	High-purity electrode coating material with fast tack performance	Fast cure conformal coating material. Low volatile. Solvent free	Fast cure conformal coating material. Solvent free	General purpose paste adhesive. UL certified		High temperature resistant paste adhesive	General purpose paste adhesive. UL certified	UL certified semiflowable adhesive / sealant.	General purpose flowable adhesive / sealant. UL certified	General purpose flowable adhesive / sealant. UL certified	General purpose flowable adhesive / sealant.	General purpose flowable adhesive / sealant.	Flowable sealant / coating material. UL certified	Fluorosilicone with high temperature performance. Good fuel, oil, moisture, UV, ozone & chemical resistance
Application	Adhesive / Sealant							●		●	●	●	●	●	●	●		●
	Coating	●	●	●	●	●	●						●	●	●	●		
	Encapsulant / Potting	●		●														
Viscosity (23°C)		Pa.s (P)	17 (170) ¹	5.0 (50) ¹	1.5 (15) ¹	1.4 (14) ¹	0.55 (5.5) ¹	0.11 (1.1) ¹	-	-	-	-	500 (5000) ¹	300 (3000) ¹	60 (600) ¹	10 (100) ¹	5.6 (56) ¹	-
Application Rate		g/min	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	88
Tack Free Time		min	10	7	7	7	5	3	10	10	60	30	60	20	90	60	30	20
Specific Gravity (23°C)			1.04	1.03	1.01	1.01	0.98	0.99	1.04	1.04	1.46	1.40	1.57	1.08	1.03	1.04	1.04	1.58
Hardness			14	20	13	25	22	35	28	29	50	31	60	25	25	16	30	42
Tensile Strength		MPa (psi)	1.3 (190)	1.2 (175)	0.4 (60)	0.8 (115)	-	-	1.9 (275)	2.0 (290)	2.9 (421)	2.4 (350)	3.9 (565)	2.0 (290)	2.3 (335)	1.5 (220)	2.0 (290)	3.33 (485)
Elongation		%	230	450	130	150	-	-	380	400	270	270	130	440	350	330	200	230
Adhesive Strength		MPa (psi)	0.7 (100)	-	0.2 (30)	0.3 (45)	-	-	1.7 (245)	1.4 (205)	1.4 (203)	1.5 (220)	1.8 (260)	2.0 (290)	1.3 (190)	1.3 (190)	1.8 (260)	-
Thermal Conductivity		W/m-K	0.18	-	0.18	-	-	-	0.18	0.18	0.59	0.25	0.67	0.18	0.18	0.18	0.18	-
Volume Resistivity		MΩ·m	2.0x10 ⁷	4.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	-
Dielectric Strength		kV/mm	23	20	26	20	20	20	23	23	22	22	21	20	20	20	20	13.7
Dielectric Constant (60Hz)			3.0	2.8	2.7	2.6	2.60	2.78	2.9	2.9	4.0	4.0	3.9	3.5	2.9	2.8	2.7	6.3 (1000Hz)
Dissipation Factor (60Hz)			0.01	0.001	0.002	0.002	0.001	0.001	0.004	0.004	0.016	0.02	0.02	0.01	0.004	0.008	0.009	-
Low Molecular Siloxane (D3-D10)		wt%	-	0.01	0.01	0.01	0.01	-	-	-	-	-	-	-	-	-	-	-
Flame Retardancy						UL94 HB			UL94 HB		UL94 V-0	UL94 V-0	UL94 V-1				UL94 HB	
Low Volatility				●	●	●	●											
Temperature Resistance									●					●				●
Thermally Conductive													●					
FDA																		
MIL-Spec ²																		
Color	White		○		○		○		○				○		○	○	○	
	Clear		○		○		○		○						○		○	
	Black				●		●		●		●			●	●		●	
	Gray								●			●				●		
	Red									●								●
Packaging	Tube		●							●	●		●					
	Cartridge		●		●		●			●	●	●	●	●		●		●
	Can					●	●											
	Pail			●			●							●				
	See Page 15 for details				●			●							●		●	

¹JIS K 6249 ²Testing is performed in accordance with current Momentive Performance Materials quality test methods, laboratory conditions, procedures, frequency and sampling.

Typical property data values should not be used as specifications

Packaging Supplement

Grade	Tube			Cartridge				Can			Pail		
	W	C	B	W	C	B	G	W	C	B	W	C	B
TN3005	○	○		○	○	●					○	○	
TN3305	○	○	●	○	○	●					○	○	
TN3705	○	○	●	○	○	●		○	○	●			●
TSE382	○	○		○	○	●	●				○	○	
TSE387	○	○		○	○	●					○	○	
TSE389		○		○	○	●			○				

W: White, C: Clear, B: Black, G: Gray

Product Details - 1 Part Condensation Cure Grades

Properties		RTV157	RTV159	RTV100 series	RTV106	TSE370	RTV116	RTV110 series
Cure Chemistry		Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy
Flowability		Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Flowable	Flowable
Features and Benefits		High strength paste adhesive	High temperature, high strength, paste adhesive	Paste adhesive with FDA, USDA, NSF, and MIL-A-46106B	High temperature resistant paste adhesive. FDA, USDA, NSF, MIL-A-46106B	Fast tack paste adhesive	High temperature resistant, flowable adhesive. FDA, USDA, NSF, MIL-A-47040, MIL-A-46106B	Flowable adhesive with FDA, USDA, NSF, MIL-A-46106B
Application	Adhesive / Sealant	●	●	●	●	●	●	
	Coating							●
	Encapsulant / Potting						●	●
Viscosity (23°C)	Pa.s (P)	-	-	-	-	-	25 (250) ¹	20 (200) ¹
Application Rate	g/min	155	175	400	400	-	-	-
Tack Free Time	min	45	45	20	20	5	30	20
Specific Gravity (23°C)		1.09	1.09	1.05	1.07	1.04	1.09	1.05
Hardness		28	20	30	30	22	20	25
Tensile Strength	MPa (psi)	6.2 (900)	7.0 (1,025)	2.75 (400)	2.55 (370)	2.5 (365)	2.45 (355)	2.20 (320)
Elongation	%	825	350	450	400	530	350	325
Adhesive Strength	MPa (psi)	1.3 (183) ³	-	1.4 (200) ²	1.4 (200) ²	2.2 (320) ²	0.9 (125) ²	0.7 (100) ²
Thermal Conductivity	W/m-K	-	-	-	-	0.18	-	-
Volume Resistivity	MΩ·m	7.5x10 ⁶	1.1x10 ⁷	3.0x10 ⁷	3.0x10 ⁶	1.0x10 ⁷	2.0x10 ⁶	6.0x10 ⁶
Dielectric Strength	kV/mm	20.7	19.7	20	20	22	16	16
Dielectric Constant (60Hz)		2.9	2.6	2.8	2.8	3.0	2.8	2.8
Dissipation Factor (60Hz)		0.0009	0.0007	0.001	0.001	0.003	0.001	0.001
Low Molecular Siloxane (D3-D10) wt%		-	-	-	-	-	-	-
Flame Retardancy								
Low Volatility								
Temperature Resistance			●		●		●	
Thermally Conductive								
FDA				●	●		●	●
MIL-Spec ²				MIL-A-46106B ³	MIL-A-46106B ³		MIL-A-46106B ³	MIL-A-46106B ³
Color	White			RTV102		●		RTV112
	Clear			RTV108		●		RTV118
	Black			RTV103		●		
	Gray	●						
	Red		●		●		●	
	Aluminum			RTV109				
Packaging	Tube	●	●	●	●	●	●	●
	Cartridge	●	●	●	●			
	Can							
	Pail	●	●	●	●		●	●

¹ASTM D ²196S 2Testing is performed in accordance with current Momentive Performance Materials quality test methods, laboratory conditions, procedures, frequency and sampling ³MIL-A-46106B Group III Type I
Typical property data values should not be used as specifications

Product Details - 1 Part Heat Cure Grades

Properties		XE13-B3208	TSE3212	TSE322	TSE322S	TSE3261-G	TSE3280-G
Flowability		Non-Flowable	Semi-Flowable	Non-Flowable	Semi-Flowable	Flowable	Flowable
Features and Benefits		Paste adhesive / sealant	Thixotropic adhesive / sealant	Flowable adhesive / sealant	Flowable adhesive / sealant. UL certified	High temperature resistant flowable adhesive / sealant	Thermally conductive flowable adhesive
Application	Adhesive / Sealant	●	●	●	●	●	●
	Coating						
	Encapsulant / Potting						●
Viscosity (23°C)	Pa.s (P)	670 (6700) ¹	280 (2800) ¹	110 (1100) ¹	70 (700) ¹	50 (500) ¹	60 (600) ¹
Cure Condition	°C/h	150/1	150/1	150/1	150/1	150/1	150/1
Specific Gravity (23°C)		1.08	1.26	1.27	1.26	1.48	2.10
Hardness		50	52	45	37	52	62
Tensile Strength	MPa (psi)	4.4 (640)	3.7 (535)	3.4 (495)	3.6 (520)	4.9 (710)	3.2 (465)
Elongation	%	430	240	230	230	160	110
Adhesive Strength	MPa (psi)	3.7 (535)	2.6 (375)	2.5 (365)	2.5 (365)	2.0 (290)	2.0 (290)
Thermal Conductivity	W/m-K	0.20	0.29	0.29	0.29	0.41	0.88
Volume Resistivity	MΩ·m	1.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷	1.0x10 ⁷	2.0x10 ⁷	2.5x10 ⁶
Dielectric Strength	kV/mm	23	20	20	25	22	21
Dielectric Constant (60Hz)		3.1	3.2	3.1	3.1	3.9	4.3
Dissipation Factor (60Hz)		0.001	0.001	0.006	0.006	0.005	0.002
Flame Retardancy					UL94 HB		
Temperature Resistance						●	
Thermally Conductive							●
Color	White		●				
	Clear	●					
	Black			●			
	Gray					●	●
	Blue			●	●		
Packaging	Tube		●	●			●
	Cartridge	●	●	●	●		●
	Can		●	●	●		●
	Pail	●	●	●	●	●	●

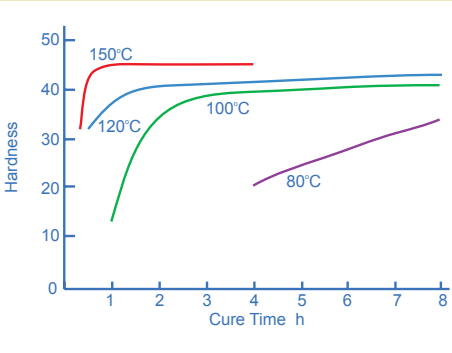
¹JIS K 6249

Typical property data values should not be used as specifications

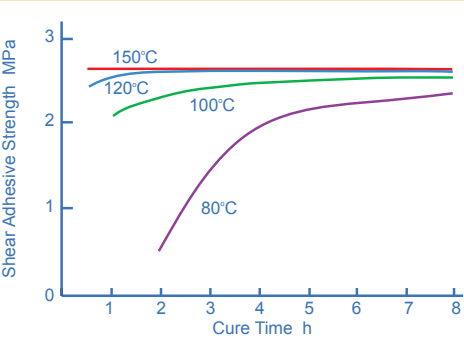
Cure Properties:

The cure performance of 1 Part Heat Cure grades is demonstrated by the relationship between temperature and hardness, and temperature and adhesive strength of TSE322 when placed in an oven at temperatures ranging from 80°C to 150°C.

Hardness & Cure Time - TSE322



Adhesion & Cure Time - TSE322



Product Details - 1 Part Heat Cure Grades

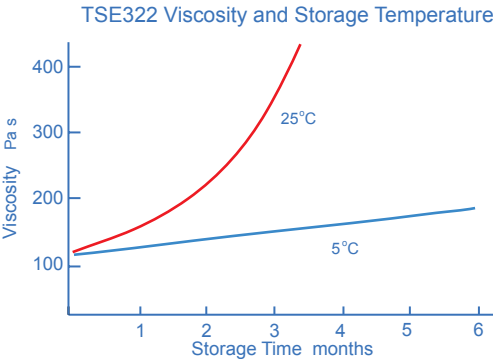
Properties		TSE3281-G	TSE3221S	TSE326	TSE326M ³		TSE3251	TSE3251-C	TSE325	TSE325-B	TSE3250	ECC4865
Flowability		Flowable	Flowable	Flowable	Flowable		Semi-Flowable	Semi-Flowable	Flowable	Flowable	Flowable	Flowable
Features and Benefits		Thermally conductive flowable adhesive	Flowable adhesive / sealant, coating material	High temperature resistant flowable adhesive. UL certified	High temperature resistant flowable adhesive		Flowable coating material	Flowable coating material	Flowable potting / coating material	Flowable potting / coating material	Flowable potting / coating material	Low viscosity conformal coating with UV tracer, fast thermal cure & long-term viscosity stability
Application	Adhesive / Sealant	●	●	●	●							
	Coating		●				●	●	●	●	●	●
	Encapsulant / Potting								●	●	●	
Viscosity (23°C)	Pa.s (P)	60 (600) ¹	58 (580) ¹	28 (280) ¹	16 (160) ¹		8.5 (85) ¹	7.0 (70) ¹	4.0 (40) ¹	3.5 (35) ¹	1.3 (13) ¹	0.25 (2.5) ²
Cure Condition	°C/h	150/1	150/1	150/1	200/0.5		150/1	150/1	150/1	150/1	150/1	-
Specific Gravity (23°C)		2.70	1.03	1.45	1.46		1.02	1.02	1.02	1.02	0.97	1.19
Hardness		84	28	43	38		16	16	12	20	9	35
Tensile Strength	MPa (psi)	4.5 (655)	2.8 (405)	3.4 (495)	2.9 (420)		0.7 (100)	0.7 (100)	0.7 (100)	0.9 (130)	-	-
Elongation	%	50	370	170	180		200	200	200	200	-	-
Adhesive Strength	MPa (psi)	2.5 (365)	2.5 (365)	2.0 (290)	1.5 (220)		0.4 (60)	0.4 (60)	0.4 (60)	0.4 (60)	0.1 (15)	-
Thermal Conductivity	W/m·K	1.68	0.18	0.41	0.41		0.18	0.18	0.18	0.18	0.17	-
Volume Resistivity	MΩ·m	4.8x10 ⁶	6.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷		2.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁷	-
Dielectric Strength	kV/mm	15	23	22	22		20	20	21	21	21	20
Dielectric Constant (60Hz)		5.2	2.8	3.3	3.3		2.8	2.8	2.9	2.9	2.8	2.4
Dissipation Factor (60Hz)		0.002	0.001	0.02	0.02		0.002	0.001	0.001	0.001	0.001	0.01
Flame Retardancy				UL94 HB								
Temperature Resistance				●	●							
Thermally Conductive		●										
Color	White						●		●			
	Clear		●					●			●	●
	Black									●		
	Gray	●										
	Red			●	●							
Packaging	Tube		●	●								
	Cartridge			●								
	Can	●	●	●	●		●	●	●	●	●	
	Pail			●					●			●

¹JIS K 6249 ²ASTM D2196S ³TSE325M EX in Europe and the Americas.

Typical property data values should not be used as specifications

Storage Stability:

Storage under low temperature conditions is important particularly for 1-part heat cure grades to prevent viscosity increase.



Product Details - 2 Part Room Temperature Cure Grades

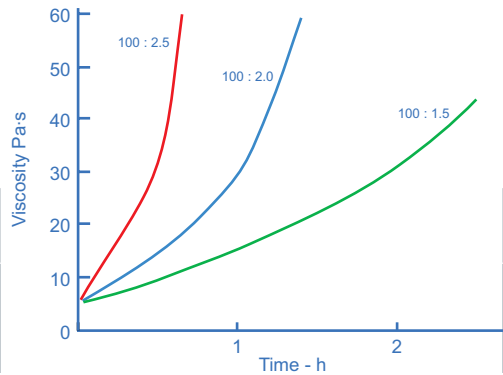
Properties		RTV577		RTV88		RTV60		RTV566				RTV31		RTV11		TSE3663		TSE3661		TSE3664K	
Components		RTV577 ³	DBT	RTV88 ³	DBT	RTV60 ³	DBT	RTV566(A) ³	RTV566(B) ³			RTV31 ³	DBT	RTV11 ³	DBT	TSE3663(A)	TSE3663(B)	TSE3661(A)	TSE3661(B)	TSE3664(A)	TSE3664(B)
Flowability		Non-Flowable		Semi-Flowable		Flowable		Flowable				Flowable		Flowable		Flowable		Flowable		Flowable	
Features and Benefits		Low temperature resistant paste sealant with good release capabilities		High temperature resistant, semi-flowable sealant. Good release capabilities		High temperature resistant flowable sealant with good release capabilities		Low volatile, low out gassing sealant with Low and High temperature performance capability				High temperature resistant flowable sealant with good release capabilities		Sealant with good release properties. FDA compliance		Flowable encapsulant / adhesive		Flowable encapsulant / adhesive		Flowable encapsulant / adhesive with fast tack free times. UL certified	
Application	Adhesive / Sealant	●		●										●							
	Coating													●							
	Encapsulant / Potting					●		●				●		●		●		●		●	
Mixing Ratio ((A):(B) by weight)		100:0.5		100:0.5		100:0.5		100:0.1				100:0.5		100:0.5		100:2		100:2		100:7.5	
Color (mixed)		White		Red		Red		Red				Red		White		Off-White		Off-White		Gray	
Viscosity (mixed) (23°C)	Pa.s (P)	700 (7000) ²		880 (8800) ²		47 (470) ²		43 (430) ²				25 (250) ²		11 (110) ²		4.0 (40) ¹		4.0 (40) ¹		3.0 (30) ¹	
Pot Life (23°C)	h	2		0.75		2		1.5				2		1.5		0.5		0.5		0.1	
Cure Condition	°C/h	25/24		25/24		25/24		25/24				25/24		25/24		23/72		23/72		23/72	
Specific Gravity (23°C)		1.35		1.47		1.48		1.49				1.42		1.19		1.19		1.19		1.41	
Hardness		48		58		57		61				54		41		42		42		60	
Tensile Strength	MPa (psi)	3.0 (440)		5.8 (840)		6.9 (995)		5.5 (795)				5.9 (870)		2.1 (300)		1.4 (205)		1.4 (205)		3.0 (435)	
Elongation		150		120		120		120				170		160		110		110		70	
Adhesive Strength		MPa (psi)		-		-		3.2 (465)				-		-		0.9 (130)		0.9 (130)		1.0 (145)	
Thermal Conductivity		W/m-K		0.31		0.31		0.31				0.31		0.29		0.27		0.27		0.42	
Volume Resistivity		MΩ-m		5.6x10 ⁶		2.8x10 ⁶		4.4x10 ⁶				1.6x10 ⁶		1.1x10 ⁷		1.0x10 ⁷		1.0x10 ⁷		5.0x10 ⁷	
Dielectric Strength		kV/mm		18.5		17.4		17.7				17		20.3		20		20		26	
Dielectric Constant (60Hz)		3.98 (1kHz)		4.3 (1kHz)		4.0 (1kHz)		3.9 (1kHz)				4.4 (1kHz)		3.3 (1kHz)		3.1		3.1		3.1	
Dissipation Factor (60Hz)		0.02 (1kHz)		0.03 (1kHz)		0.02 (1kHz)		0.02 (1kHz)				0.03 (1kHz)		0.006 (1kHz)		0.025		0.025		0.01	
Flame Retardancy																		UL94 HB		UL94 V-0	
Low Volatility								●													
Temperature Resistance		●		●		●		●				●									
FDA														●							
Packaging	Bottle																●		●		●
	Can															●		●		●	
	Pail															●		●		●	
	Kit	●		●		●		●				●		●							

¹JIS K 6249 ²ASTM D2196 3Sub-Zero long-term storage required.

Typical property data values should not be used as specifications

Cure Speed:
The cure speed of 2 Part Condensation Cure grades can be changed by adjusting the amount of the catalyst component. However, the post-cure properties of the material may vary from those achieved under standard mixing ratios, and therefore, adequate testing and confirmation prior to use in an application is required.

TSE3663 - Mixing Ratios & Viscosity (23°C)



Product Details - 2 Part Heat Cure Grades

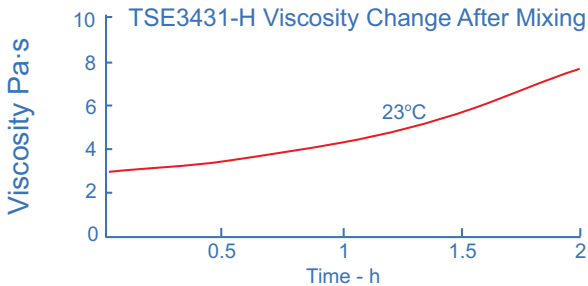
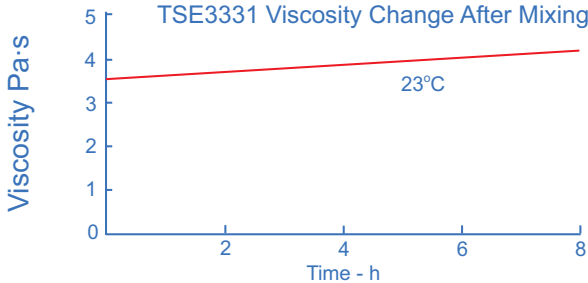
Properties		TSE3360		XE14-A0425	TSE3380		RTV615		TSE3032		TSE3331		TSE3331K EX ³			TSE3331K ²		TSE3431		TSE3431-H		XE14-B7892		YE5822		TSE3033	
Components		TSE3360(A)	TSE3360(B)	XE14-A0425(A) XE14-A0425(B)	TSE3380(A)	TSE3380(B)	RTV615(A)	RTV615(B)	TSE3032(A)	TSE3032(B)	TSE3331(A)	TSE3331(B)	TSE3331KEX(A)	TSE3331KEX(B)		TSE3331K(A)	TSE3331K(B)	TSE3431(A)	TSE3431(B)	TSE3431(A)	TSE3431(B)	XE14-B7892(A)	XE14-B7892(B)	YE5822(A)	YE5822(A)	TSE3033(A)	TSE3033(B)
Flowability		Non-Flowable		Semi-Flowable	Flowable		Flowable		Flowable		Flowable		Flowable			Flowable		Flowable		Flowable		Flowable		Flowable		Flowable	
Features and Benefits		General purpose paste adhesive with extended pot life		High temperature resistant paste adhesive with thermal conductive performance	Thermally conductive paste adhesive		Low viscosity encapsulant / potting material with capability to cure at RT. FDA recognition		Transparent encapsulant / potting material with good release properties		Thermally conductive encapsulant / potting material. UL certified		Thermally conductive encapsulant / potting material. UL certified			Thermally conductive encapsulant / potting material. UL certified		Encapsulant / potting material with UL certified, thermal conductivity, and good release properties		Encapsulant / potting material with UL certified, thermal conductivity, and good release properties		Encapsulant / potting material with UL certified, low temperature cure, and good release properties		Low viscosity transparent encapsulant / potting material. Good release properties		Low viscosity transparent encapsulant / potting material	
Application	Adhesive / Sealant	●		●	●																						
	Coating										●		●			●										●	
	Encapsulant / Potting						●		●		●		●			●		●		●		●		●		●	
Mixing Ratio ((A):(B) by weight)		100:100		100:100	100:100		100:10		100:10		100:100		100:100			100:100		100:10		100:10		100:100		100:10		100:100	
Color (mixed)		White		Reddish Brown	Gray		Transparent		Transparent		Gray		Dark Gray			Dark Gray		Black		Black		Black		Transparent		Transparent	
Viscosity (mixed) (23°C)	Pa.s (P)	640 (6400) ¹		400 (4000) ¹	40 (400) ¹		4.0 (40) ²		4.0 (40) ¹		3.5 (35) ¹		3.0 (30) ¹			2.6 (26) ¹		2.6 (26) ¹		2.6 (26) ¹		1.3 (13) ¹		1.0 (10) ¹		0.9 (9) ¹	
Pot Life (23°C)	h	24		24	8		4		4		8		8			8		1.5		1.5		2		4		6	
Cure Condition	°C/h	150/1		150/1	150/0.5		150/0.25		100/1		120/1		120/1			120/1		100/1		100/1		60/1		100/1		150/0.5	
Specific Gravity (23°C)		1.12		2.11	2.70		1.02		1.02		1.51		1.43			1.43		1.50		1.52		1.39		0.97		1.01	
Hardness		42		65	70		44		35		60		50			45		70		70		60		27		30	
Tensile Strength	MPa (psi)	5.4 (785)		5.0 (725)	2.5 (365)		6.3 (920)		4.5 (655)		2.9 (420)		3.0 (440)			3.1 (450)		4.9 (710)		4.1 (595)		3.5 (510)		0.4 (58)		1.0 (145)	
Elongation	%	380		120	100		120		210		70		100			120		70		60		100		130		130	
Adhesive Strength	MPa (psi)	3.1 (450)		2.9 (420)	1.5 (220)		-		-		1.3 (190)		1.6 (230)			1.6 (230)		-		-		-		-		0.3 (44)	
Thermal Conductivity	W/m-K	0.23		0.80	1.68		0.19		0.17		0.63		0.53			0.53		0.63		0.63		0.44		0.17		0.17	
Volume Resistivity	MΩ·m	1.0x10 ⁷		2.0x10 ⁶	2.1x10 ⁶		1.8x10 ⁷		2.0x10 ⁷		2.0x10 ⁶		6.0x10 ⁶			6.0x10 ⁶		5.0x10 ⁷		5.0x10 ⁶		2.0x10 ⁷		2.0x10 ⁷		2.0x10 ⁷	
Dielectric Strength	kV/mm	21		26	15		19.7		21		26		22			22		26		27		27		21		21	
Dielectric Constant (60Hz)		3.0		3.4	5.7		2.7 (1kHz)		2.8		3.4		3.1			3.1		3.4		3.5		3.1		2.8		2.8	
Dissipation Factor (60Hz)		0.001		0.017	0.002		0.0006 (1kHz)		0.001		0.017		0.015			0.015		0.014		0.014		0.01		0.001		0.001	
Flame Retardancy											UL94 V-0		UL94 V-0			UL94 V-0		UL94 V-0		UL94 V-0		UL94 V-0					
Temperature Resistance				●																							
Thermally Conductive				●	●						●		●			●		●		●							
FDA							●																				
Packaging	Bottle									●									●		●				●		
	Can			●	●				●		●	●	●	●		●	●	●	●	●	●	●	●	●	●	●	●
	Pail	●	●			●	●		●		●	●						●		●		●	●			●	●
	Kit						●																				

¹JIS K 6249 ²ASTM D2196 3Sub-Zero long-term storage required.

Typical property data values should not be used as specifications

Pot Life:

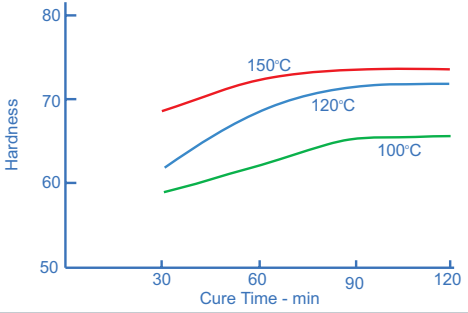
The pot life of a 2 Part Heat Cure grade is affected by changes in viscosity that occur after the components have been mixed.



Cure Properties:

The cure performance of 2 Part Heat Cure grades is demonstrated by the relationship between temperature and hardness of TSE3380 when placed in an oven at temperatures ranging from 100°C to 150°C.

Hardness & Cure Time - TSE3380



Product Details - 1 Part Gels

Properties		TSE3051	TSE3051-FR	TSE3051-L	TSE3053
Flowability		Flowable	Flowable	Flowable	Flowable
Features and Benefits		Low viscosity	Low viscosity, UL certified	Low viscosity, low penetration	Low viscosity, high penetration
Viscosity (23°C)	Pa.s (P)	0.7 (7) ¹	0.7 (7) ¹	0.7 (7) ¹	0.7 (7) ¹
Cure Condition	°C/h	125/2	150/1	125/2	125/2
Specific Gravity (23°C)		0.97	0.97	0.97	0.97
Penetration		85	85	65	105
Thermal Conductivity	W/m.K	0.17	0.17	0.17	0.17
Volume Resistivity	MΩ.m	1.0x10 ⁷	5.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷
Dielectric Strength	kV/mm	18	18	18	18
Dielectric Constant (60Hz)		2.8	2.8	2.8	2.8
Dissipation Factor (60Hz)		0.001	0.001	0.001	0.001
Flame Retardancy			UL94 V-1		
Color	White	●			
	Transparent	●	●	●	●
	Gray	●			
Pkg	1kg can	See below matrix	●	●	●
	15kg can		●	●	

¹JIS K 6249 Typical property data values should not be used as specifications

TSE3051	W	C	G
1kg bottle	●	●	●
4kg can		●	
15kg can		●	
20kg pail		●	●

W: White, C: Clear, G: Gray



Product Details - 2 Part Gels

Properties		TSE3062	TSE3070	RTV6136-D1	
Components		TSE3062(A) TSE3062(B)	TSE3070(A) TSE3070(B)	RTV6126(A) RTV6126(B)	
Flowability		Flowable	Flowable	Flowable	
Features and Benefits		Low temperature cure	High elongation gel	Fast cure, low viscosity	
Mixing Ratio ((A):(B) by weight)		100:100	100:100	100:100	
Color (mixed)		Transparent	Transparent	Transparent	
Viscosity (mixed) (23°C)	Pa.s (P)	1.0 (10) ¹	0.8 (8) ¹	0.75 (7.5) ²	
Pot Life (23°C)	h	1	4	0.5	
Cure Condition	°C/h	70/0.5	70/0.5	100/0.3	
Specific Gravity (23°C)		0.97	0.97	0.98	
Penetration		55	65	60	
Thermal Conductivity	W/m.K	0.17	0.17	0.19	
Volume Resistivity	MΩ.m	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷	
Dielectric Strength	kV/mm	18	18	20.5	
Dielectric Constant (60Hz)		2.7	2.7	2.8 (1kHz)	
Dissipation Factor (60Hz)		0.001	0.001	0.001 (1kHz)	
Package	Bottle		● ●		
	Can	● ●			
	Pail			●	

¹JIS K 6249 ²ASTM D2196
Typical property data values should not be used as specifications

Product Details - 1 Part JCR Grades

Properties	TSJ3155	TSJ3195-W	TSJ3185
Flowability	Semi-Flowable	Semi-Flowable	Semi-Flowable
Features and Benefits	Thixotropic JCR rubber. Low post-cure hardness contributes to stress relief of critical components	Low viscosity JCR gel. Provides stress and vibration relief performance	Thixotropic JCR gel. Provides stress and vibration relief performance
Property	Rubber	Gel	Gel
Viscosity (23°C) Pa.s (P)	6 (60) ¹	4 (40) ¹	3 (30) ¹
Color	White	White	Translucent
Cure Condition °C/h	150/4	150/4	150/4
Specific Gravity (23°C)	1.02	1.00	1.01
Hardness	11	-	-
Penetration	-	80	80
Thermal Conductivity W/m·K	0.18	0.18	0.18
Volume Resistivity MΩ·m	1.0x10 ⁷	1.0x10 ⁷	1.0x10 ⁷
Dielectric Strength kV/mm	20	15	15
Dielectric Constant (60Hz)	2.8	2.8	2.7
Dissipation Factor (60Hz)	0.0004	0.0004	0.001
Na ⁺ K ⁺ ppm	<2	<2	<2
Pkg: 500g bottle	●	●	●

¹JIS K 6249 Typical property data values should not be used as specifications

Product Details - Grease

Properties	TSK5303	TSK5370	TSK550	TSK551	YG6111	YG6240	YG6260	TIG1000
Features and Benefits	Thermally conductive compound for medium heat dissipation. Heat resistance	Compound for electrical insulation & sealing with swell resistant performance	Compound for electrical contact insulation protection against moisture & contaminants	Compound for electrical contact insulation protection against moisture & contaminants	Thermally conductive compound for medium heat dissipation. Low oil separation	Thermally conductive compound for medium heat dissipation. Low oil separation	Thermally conductive compound for medium heat dissipation. Low oil separation	Thermally conductive compound for medium to high heat dissipation applications
Color	White	White	White	Green	White	White	White	White
Specific Gravity	2.34	-	1.03	1.03	2.45	2.45	2.30	2.50
Penetration	330	270	220	220	310	290	300	340
Bleed (150°C, 24h) %	2.8	1.5	1.5	1.0	0.4	0.0	0.5	0.1
Evaporation (150°C, 24h) %	0.2	0.2	0.2	0.3	0.1	0.4	0.1	0.1
Thermal Conductivity W/m·K	0.84	-	-	-	0.84	0.84	0.84	1.00
Volume Resistivity MΩ·m	-	1.0x10 ⁵	2.0x10 ⁷	2.0x10 ⁷	2.0x10 ⁶	2.0x10 ⁶	2.0x10 ⁷	3.0x10 ⁶
Dielectric Constant (60Hz)	5.0	2.5	2.8	2.8	5.0	5.0	5.0	5.0
Dissipation Factor (60Hz)	0.005	0.0001	0.0002	0.0002	0.006	0.006	0.005	0.006
Low Molecular Siloxane (D3-D10) wt%	0.0015	0.01	-	-	0.01	0.003	0.003	0.003
Arc Resistance ¹ s	-	-	120<	120<	-	-	-	-
Low Volatility	●	●			●	●	●	●
Temperature Resistance	●							
Thermally Conductive	●				●	●	●	●
Low Bleed						●		
Packaging	Bottle	●	●	●	●	●	●	
	Can	●	●	●		●	●	●
	Pail		●			●	●	

¹ASTM D-495 Typical property data values should not be used as specifications

Product Details - 2 Part JCR Grades

Properties	XE14-B5778	TSJ3175
Components	XE14-B5778(A) XE14-B5778(B)	TSJ3175(A) TSJ3175(B)
Flowability	Semi-Flowable	Semi-Flowable
Features and Benefits	Flow-controllable JCR rubber.	Thixotropic JCR gel. Soft gel property contributes to stress and vibration relief
Property	Rubber	Gel
Mixing Ratio ((A):(B) by weight)	100:100	100:100
Color (mixed)	Translucent	Black
Viscosity (mixed) (23°C) Pa.s (P)	14 (140) ¹	17 (170) ¹
Pot Life (23°C) h	8	12
Cure Condition °C/h	80/2	125/2
Specific Gravity (23°C)	1.02	1.01
Hardness	16	-
Penetration	-	70
Thermal Conductivity W/m·K	0.17	0.18
Volume Resistivity MΩ·m	2.0x10 ⁵	1.0x10 ⁷
Dielectric Strength kV/mm	24	15
Dielectric Constant (60Hz)	2.7	2.7
Dissipation Factor (60Hz)	0.001	0.001
Na ⁺ K ⁺ ppm	<2	<2
Pkg: 500g bottle	●	●

¹JIS K 6249 Typical property data values should not be used as specifications

UL Certifications

source: Underwriters Laboratories Inc.

Type	Grade	Color	Thickness mm	RTI		Flame Class	HWI (PLC)	HAI (PLC)	HVTR (PLC)	D495 (PLC)	CTI (PLC)	File No.
				Elec.	Mech.							
1 Part Condensation Cure	ECS0601	Black Clear White	1.5	105	105	HB	-	-				E56745
	ECS0609FR	Gray	0.2	105	105	V-0	-	-				E56745
		Gray	3.0	105	105	V-0	-	-				
	TN3085	Gray	1.0	105	105	V-1	0	0	0	4	0	E56745
		Gray	3.0	105	105	V-0	0	0				
		White	1.0	105	105	V-1	2	0	0	3	0	
		White	3.0	105	105	V-0	1	0	0	3	0	
	RTV133	Black	0.71	105	105	V-1	3	0				E36952
		Black	1.6	105	105	V-1	2	0	0	3	0	
		Black	3.4	105	105	V-0	1	0	0	3	0	
	RTV160	White	0.75	105	105	HB	4	0				E36952
		White	1.5	105	105	HB	3	0	1	5	0	
		White	2.5	105	105	HB	3	0	1	5	0	
		White	3.0	105	105	HB	-	-	1	5	0	
	RTV167	Gray	0.83	105	105	HB	3	0				E36952
		Gray	1.5	105	105	HB	2	0	0	5	0	
		Gray	2.6	105	105	HB	2	0	0	5	0	
	TSE382	Clear White	0.75	105	105	HB	4	0				E56745
		Clear White	1.5	105	105	HB	3	0	0	4	0	
		Clear White	1.9	150	140	HB	3	0	0	4	0	
		Clear White	3.0	150	140	HB	3	0	0	4	0	
	TSE3826	Red	2.0	200	200	-	-	-				E56745
		Red	3.0	200	200	-	-	-				
	TSE3840-G	Gray	0.75	105	105	V-0	-	-				E56745
		Gray	1.5	105	105	V-0	0	0	0	2	0	
		Gray	3.0	105	105	V-0	0	0	0	2	0	
		Gray	3.0	105	105	V-0	0	0	0	2	0	
	TSE3843-W	White	1.1	105	105	V-1	-	-				E56745
		White	1.5	105	105	V-1	0	0				
		White	1.9	150	140	V-1	-	-	0	1	1	
		White	2.5	150	140	V-1	-	-	0	1	1	
		White	3.0	150	140	V-1	-	-	0	1	1	
	TSE384-B	Black	1.2	105	105	V-0	0	0				E56745
		Black	1.9	150	140	V-0	-	-	0	3	1	
		Black	3.0	150	140	V-0	-	-	0	3	1	
	TSE3853-W	White	1.5	105	105	V-0	0	3				E56745
		White	3.0	105	105	V-0	0	3	0	3	0	
	TSE3854DS	Gray	0.75	105	105	V-0	0	0				E56745
		Gray	1.5	105	105	V-0	0	0	0	3	0	
		Gray	3.0	105	105	V-0	0	0	0	3	0	
		White	1.5	105	105	V-0	0	3				
		White	3.0	105	105	V-0	0	3				
	TSE389	Clear White Black	1.5	105	105	HB	-	-				E56745
		Clear White Black	3.0	105	105	HB	-	-				
	TSE3944	Gray	0.75	105	105	V-0	-	-				E56745
		White	0.75	105	105	V-1	-	-	0	3	0	
		Gray White	1.5	105	105	V-0	0	0	0	3	0	
		Gray White	3.0	105	105	V-0	0	0	0	3	0	

RTI: Relative Temperature Index PLC: Performance Level Category HWI: Hot Wire Ignition HAI: High-Current Arc Ignition
HVTR: High-Voltage Arc Tracking Rate D495: D495 High-Voltage Dry Arc Resistance CTI: Comparative Tracking Index

Type	Grade	Color	Thickness mm	RTI		Flame Class	HWI (PLC)	HAI (PLC)	HVTR (PLC)	D495 (PLC)	CTI (PLC)	File No.																																																																																																																																																					
				Elec.	Mech.																																																																																																																																																												
1 P Cond Cure	TSE3976-B	Black	0.64	105	105	HB	-	-				E56745																																																																																																																																																					
		Black	1.5	105	105	HB	-	-																																																																																																																																																									
		Black	3.0	105	105	HB	-	-																																																																																																																																																									
	XE11-A5133S	White	3.0	105	105	V-1	-	-				E56745																																																																																																																																																					
	XE11-B5320	White	1.5	105	105	HB	-	-				E56745																																																																																																																																																					
		White	3.0	105	105	HB	-	-																																																																																																																																																									
1 Part Heat Cure	TSE3051-FR	Clear	2.7-3.3	105	105	V-1	-	-				E56745																																																																																																																																																					
	TSE322S N	NC	1.0	105	105	HB	-	-				E56745																																																																																																																																																					
		NC	1.5	105	105	HB	-	-																																																																																																																																																									
		NC	3.0	105	105	HB	-	-																																																																																																																																																									
	TSE326	Red	1.0	105	105	HB	-	-				E56745																																																																																																																																																					
		Red	3.0	105	105	HB	-	-																																																																																																																																																									
2 Part	TSE3331	Black	1.0	105	105	V-0	-	-	0	0	0	E56745																																																																																																																																																					
		Black	1.6	105	105	V-0	2	0																																																																																																																																																									
		Black	2.0	105	105	V-0	-	-																																																																																																																																																									
		Black	3.0	105	105	V-0	0	0																																																																																																																																																									
	TSE3331K	Black	2.5	105	105	V-0	-	-				E56745																																																																																																																																																					
		Black	3.0	105	105	V-0	-	-																																																																																																																																																									
	TSE3331K EX	Black	2.5	105	105	V-0	-	-				E56745																																																																																																																																																					
		Black	3.0	105	105	V-0	-	-																																																																																																																																																									
	TSE3431	Gray	2.0	105	105	V-1	-	-				E56745																																																																																																																																																					
		Gray	4.0	105	105	V-0	-	-																																																																																																																																																									
	TSE3431-H	Gray	1.0	105	105	V-0	0	0	0	1	1	E56745																																																																																																																																																					
		Gray	1.5	105	105	V-0	-	-																																																																																																																																																									
		Gray	2.5	105	105	V-0	0	0																																																																																																																																																									
		Gray	3.0	105	105	V-0	-	-																																																																																																																																																									
	TSE3664K	Gray	1.0	105	105	V-1	-	-				E56745																																																																																																																																																					
		Gray	2.0	105	105	V-0	-	-																																																																																																																																																									
		Gray	3.0	105	105	V-0	0	0																																																																																																																																																									
	XE14-B7892	Black	2.0	105	105	V-1	-	-				E56745																																																																																																																																																					
		Black	3.0	105	105	V-0	-	-																																																																																																																																																									
	TSE3661	All	1.0	105	105	HB	4	0			0	E56745																																																																																																																																																					
		All	3.0	105	105	HB	3	0																																																																																																																																																									
<table><tr><td colspan="3">HWI</td><td colspan="3">HAI</td><td colspan="3">HVTR</td><td colspan="3">D495</td><td colspan="2">CTI</td></tr><tr><td>Resistance to ignition when exposed to high temperatures. Expressed as the mean number of seconds required to ignite a specimen when wrapped with an energized ni-chrome resistive wire that dissipates a specified level of energy.</td><td>Mean Ignition Time (sec)</td><td>PLC</td><td>Ability to withstand electrical arcing. Expressed as the number of arc rupture exposures required to ignite a specimen when the arc occurs directly on the surface or a specified distance above the test specimen.</td><td>Mean No. of Arcs</td><td>PLC</td><td>Expressed as the rate (inches per minute) that a tracking path can be produced on the surface of the material under standardized test conditions.</td><td>HVTR Range (in mm/min)</td><td>PLC</td><td>Expressed as the number of seconds that a material resists the formation of a surface-conducting path when subjected to an intermittently occurring arc of high voltage, low current characteristics.</td><td>Arc Resistance (sec)</td><td>PLC</td><td>Expressed as that voltage which causes tracking after 50 drops of 0.1% ammonium chloride solution have fallen on the material.</td><td>Tracking Index (volts)</td><td>PLC</td></tr><tr><td></td><td>≥ 120</td><td>0</td><td></td><td>≥ 120</td><td>0</td><td></td><td>0 - 10</td><td>0</td><td></td><td>≥ 420</td><td>0</td><td></td><td>≥ 600</td><td>0</td></tr><tr><td></td><td>60 - 119</td><td>1</td><td></td><td>60 - 119</td><td>1</td><td></td><td>10.1 - 25.4</td><td>1</td><td></td><td>360 - 419</td><td>1</td><td></td><td>400 - 599</td><td>1</td></tr><tr><td></td><td>30 - 59</td><td>2</td><td></td><td>30 - 59</td><td>2</td><td></td><td>25.5 - 80</td><td>2</td><td></td><td>300 - 359</td><td>2</td><td></td><td>250 - 399</td><td>2</td></tr><tr><td></td><td>15 - 29</td><td>3</td><td></td><td>15 - 29</td><td>3</td><td></td><td>80.1 - 150</td><td>3</td><td></td><td>240 - 299</td><td>3</td><td></td><td>175 - 249</td><td>3</td></tr><tr><td></td><td>7 - 14</td><td>4</td><td></td><td><15</td><td>4</td><td></td><td>>150</td><td>4</td><td></td><td>180 - 239</td><td>4</td><td></td><td>100 - 174</td><td>4</td></tr><tr><td></td><td><7</td><td>5</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>120 - 179</td><td>5</td><td></td><td><100</td><td>5</td></tr><tr><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>60 - 119</td><td>6</td><td></td><td></td><td></td></tr><tr><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td><60</td><td>7</td><td></td><td></td><td></td></tr></table>													HWI			HAI			HVTR			D495			CTI		Resistance to ignition when exposed to high temperatures. Expressed as the mean number of seconds required to ignite a specimen when wrapped with an energized ni-chrome resistive wire that dissipates a specified level of energy.	Mean Ignition Time (sec)	PLC	Ability to withstand electrical arcing. Expressed as the number of arc rupture exposures required to ignite a specimen when the arc occurs directly on the surface or a specified distance above the test specimen.	Mean No. of Arcs	PLC	Expressed as the rate (inches per minute) that a tracking path can be produced on the surface of the material under standardized test conditions.	HVTR Range (in mm/min)	PLC	Expressed as the number of seconds that a material resists the formation of a surface-conducting path when subjected to an intermittently occurring arc of high voltage, low current characteristics.	Arc Resistance (sec)	PLC	Expressed as that voltage which causes tracking after 50 drops of 0.1% ammonium chloride solution have fallen on the material.	Tracking Index (volts)	PLC		≥ 120	0		≥ 120	0		0 - 10	0		≥ 420	0		≥ 600	0		60 - 119	1		60 - 119	1		10.1 - 25.4	1		360 - 419	1		400 - 599	1		30 - 59	2		30 - 59	2		25.5 - 80	2		300 - 359	2		250 - 399	2		15 - 29	3		15 - 29	3		80.1 - 150	3		240 - 299	3		175 - 249	3		7 - 14	4		<15	4		>150	4		180 - 239	4		100 - 174	4		<7	5								120 - 179	5		<100	5											60 - 119	6														<60	7			
HWI			HAI			HVTR			D495			CTI																																																																																																																																																					
Resistance to ignition when exposed to high temperatures. Expressed as the mean number of seconds required to ignite a specimen when wrapped with an energized ni-chrome resistive wire that dissipates a specified level of energy.	Mean Ignition Time (sec)	PLC	Ability to withstand electrical arcing. Expressed as the number of arc rupture exposures required to ignite a specimen when the arc occurs directly on the surface or a specified distance above the test specimen.	Mean No. of Arcs	PLC	Expressed as the rate (inches per minute) that a tracking path can be produced on the surface of the material under standardized test conditions.	HVTR Range (in mm/min)	PLC	Expressed as the number of seconds that a material resists the formation of a surface-conducting path when subjected to an intermittently occurring arc of high voltage, low current characteristics.	Arc Resistance (sec)	PLC	Expressed as that voltage which causes tracking after 50 drops of 0.1% ammonium chloride solution have fallen on the material.	Tracking Index (volts)	PLC																																																																																																																																																			
	≥ 120	0		≥ 120	0		0 - 10	0		≥ 420	0		≥ 600	0																																																																																																																																																			
	60 - 119	1		60 - 119	1		10.1 - 25.4	1		360 - 419	1		400 - 599	1																																																																																																																																																			
	30 - 59	2		30 - 59	2		25.5 - 80	2		300 - 359	2		250 - 399	2																																																																																																																																																			
	15 - 29	3		15 - 29	3		80.1 - 150	3		240 - 299	3		175 - 249	3																																																																																																																																																			
	7 - 14	4		<15	4		>150	4		180 - 239	4		100 - 174	4																																																																																																																																																			
	<7	5								120 - 179	5		<100	5																																																																																																																																																			
										60 - 119	6																																																																																																																																																						
										<60	7																																																																																																																																																						

Typical Adhesion Performance

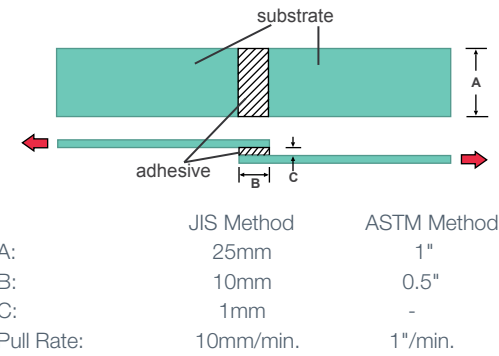
Condensation Cure Grades

Substrate		Alkoxy				Acetoxys			Oxime			XP80-A5363 / YP9341
		Primer-less	ME121	ME123	XP80-A5363	Primer-less	ME121	ME123	Primer-less	ME121	ME123	
Metals	Copper	●	●			● ¹	● ¹		▲ ¹	● ¹		
	Steel	●	●			▲	●		●	●		
	Brass	●	●			▲ ¹	▲ ¹		▲ ¹	● ¹		
	Stainless Steel	●	●			▲	●		●	●		
	Aluminum	●	●			●	●		●	●		
	Galvanized Steel	●	●				●		●	●		
	Tin	●	●			●	●		●	●		
Plastic	Acrylic Resin	●		●		×		●	●	●		
	Phenol Resin	●		●		●		●	●	●		
	Epoxy Resin	●		●		●		●	●	●		
	Polycarbonate	● ²		● ²					● ²	● ²		
	Soft Polyvinyl Chloride	●		●		×		●	×	×	●	
	Rigid Polyvinyl Chloride	●		●		●		●	●	●	●	
	Polyester Film	●		●		▲		●	●	●	●	
	Unsaturated Polyester	●		●		●		●	●	●	●	
	Polyamide	●		●		●		●	●	●	●	● ³
	Nylon 66	●		●					●		●	
	PBT	●		●					▲		●	● ³
	PPS	●		●					▲		●	
	ABS	●		●		●		●	●	●	●	● ⁴
	Polypropylene	×		×	●				×	×	×	
	Polyethylene	×		×	▲	×		×	×	×	×	
	Fluorocarbon Resin	×		×		×		×	×	×	×	
	Silicone Resin Laminate	●		●		●		●	●	●		
Rubber	Chloroprene Rubber	▲		●		▲		●	▲		●	
	Nitrile Rubber	▲		●		●		●	▲		●	
	Styrene Butadiene Rubber	▲		●					▲		●	
	Ethylene Propylene Rubber	▲		●					▲		●	
	Silicone	●		●		●		●	●		●	
Inorganic	Glass	●	●			●	●		●	●		
	Ceramic	●	●			●	●		●	●		

● Adheres completely, ▲ Adheres, but separates from surface when pulled, × Does not adhere
¹ May corrode under some usage conditions, ² Stress cracking may occur under some usage conditions, ³ YP9341, ⁴ XP80-A5363

Substrate	Condensation Cure							Addition Cure				General
	ME121	ME123	YP9341	XP80-A5363	SS4004P	SS4044P	SS4179	ME151	ME153	XP81-B0016	SS4120	SS4155
Appearance	Yellow Transparent	Yellow Transparent	Transparent	Yellow Transparent	Pink	Yellow	Clear Colorless	Yellow	Yellow Transparent	Yellow Transparent	Clear Colorless	Blue
Substrates	Metals, Glass, Plastic	Plastic, Rubber	Plastic, Rubber	Polylefins	Metals	Metals	Plastic	Metals, Glass, Plastic, Ceramic	Plastic	Metals, Glass	-	-
Specific Gravity (23°C)	0.85	0.86	0.89	0.88	0.85	0.85	0.98	0.87	0.83	0.71	0.82	0.82
Non-Volatile Content	15%	15%	8%	7%	15%	15%	6%	24%	15%	7.5%	3%	10%
Drying Time (23°C) min	30	30	30	20	30	30	15	30	30	30	30	30
Solvents	Acetone Toluene IPA	Acetone Toluene IPA	Butyl Acetate	Toluene	Acetone Xylene N-butanol IPA	Acetone Xylene N-butanol IPA	Ethyl Acetate Toluene Methanol	Toluene IPA	Toluene IPA	n-hexane	Ethanol Methanol	Mineral Spirits

Shear Adhesion Test Method

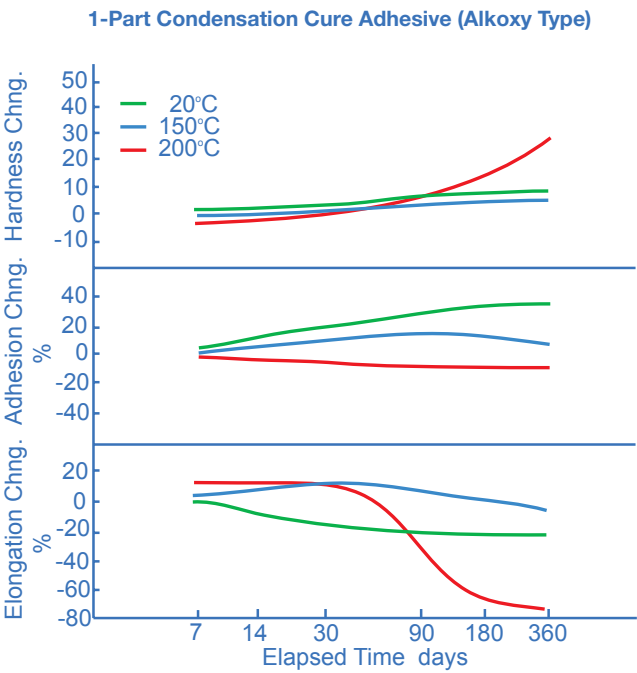


Typical Chemical Resistance

Chemical		Volume Change
Acid	Concentrated Hydrochloric Acid	◎
	Hydrochloric Acid (3%)	◎
	Concentrated Sulphuric Acid	Decomposition
	Sulphuric Acid (10%)	◎
	Concentrated Nitric Acid	△
	Nitric Acid (7%)	◎
	Glacial Acetic Acid	◎
	Acetic Acid	◎
	Hydrofluoric Acid	Decomposition
	Citric Acid	◎
	Phosphoric Acid	◎
Alkali	Concentrated Ammonia	◎
	Ammonia (10%)	◎
	Potassium Hydroxide (20%)	◎
	Sodium Hydroxide (1%)	◎
	Sodium Hydroxide (20%)	◎
	Sodium Hydroxide (50%)	◎
Inorganic Saline Solution	Sodium Chloride (10%)	◎
	Sodium Carbonate (2%)	◎
	Sodium Carbonate (20%)	◎
	Hydrogen Peroxide (3%)	◎
Oil	ASTM No.1 Oil (150°C, 70h)	◎
	ASTM No.3 Oil (150°C, 70h)	△
	Mineral Oil	◎
	Castor Oil	◎
	Flax Seed Oil	◎
	Silicone Oil (35°C, 70h)	△
Solvent	Acetone	△
	Butyl Alcohol	○
	Ethyl Alcohol	◎
	Gasoline	X
	Mineral Spirit	X
	Toluene	X
Water	Water (room temperature)	◎
	Boiling Water (70h)	◎

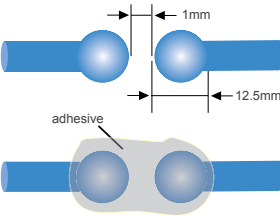
◎ : <10%, ○ : 10-25%, △ : 25-75%, X : >75%
Test Method:
Volume change of cured silicone rubber after immersing 1 week at 25°C

Typical Heat Resistance



Typical Electrical Performance

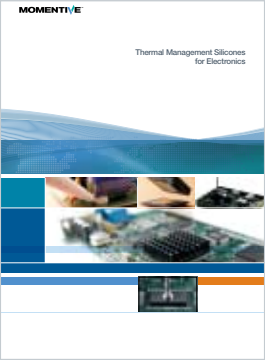
Dielectric Strength Test Method:
Equipment:
Dielectric voltage gauge
Voltage Rise:
1kV/s
Terminal Gap:
1mm (JIS C 2110)



Electrical Performance of Cured Material

TSE3843-W	Volume Resistivity MΩ·m		Dielectric Strength kV/mm	
Conditions	40°C, 95%RH	25°C Immersed	40°C, 95%RH	25°C Immersed
Initial	1.6x10 ⁷	1.6x10 ⁷	29	29
1 Day	2.9x10 ⁶	2.2x10 ⁶	27	25
2 Days	2.5x10 ⁶	3.6x10 ⁶	29	22
3 Days	2.7x10 ⁶	1.9x10 ⁶	24	23

Other Electronic Solutions from Momentive Performance Materials



Provides detailed information on silicone materials used for thermal management applications in electronics and micro-electronics. Includes SilCool® grease & adhesives, and conventional grades for adhesion, encapsulation and potting.



Provides opto-electronic solutions for LED Packages and Assemblies. Includes InvisiSil® LED encapsulants, Glob Top, Lens fabrication materials, Die Attach adhesives, and Dot Matrix assembly materials.

Frequently Asked Questions

What does RTV mean?
RTV stands for Room Temperature Vulcanization (cure). Despite the low-temperature connotations conveyed by this name, RTV silicones consist of both Room Temperature Cure and Heat Cure grades.

What is the cure mechanism of a condensation cure product?
Condensation cure silicone products cure when exposed to atmospheric moisture. Moisture in the air is generally required to cure (or vulcanize) condensation cure products. The cure process begins from the outer surface, and therefore time is required for complete cure. The cure time is affected by the reaction mechanism and viscosity of the material. Generally, at 25C and 50%RH, condensation cure RTV silicones cure through in 24 to 48 hours. Full physical properties may take up to 7 days to develop.

What is the depth (bead thickness) limit for a condensation cure grade?
For 1-part, condensation cure products, the depth (bead thickness) limitation is approximately 6mm (1/4"). For 2-part, condensation cure products, the depth (bead thickness) limitation is approximately 25mm (1").

Can I accelerate the cure time of a 1-part product?
Condensation cure silicone cure rates depend on humidity, silicone thickness, and to a smaller degree heat. Increasing the relative humidity around the silicone or reducing the thickness of the material will reduce the time to cure the material. Increased heat (not over 50C) will somewhat reduce cure time but as mentioned will do so to a much smaller degree than humidity or thickness.

What is the cure mechanism of an addition cure product?
Addition cure silicone RTV products may be 1 or 2-part and cure when exposed to heat.

Although some heat cure products can cure at room temperature, higher heat greatly accelerates the cure. 1-part heat cure products typically have an inhibitor in the formulation that stops the product from curing until an activation temperature, greater than room temperature, is achieved and the inhibitor is driven off and the cure reaction is allowed to proceed.

What does "tack free time" mean?
Tack free refers to the amount of time it takes for a condensation cure silicone product to form a cured outer layer (the cured outer layer is not tacky like uncured material).

What is "mix ratio"?
Mix ratio is a term used to state the amount of each material to be in a multi-component material. The mix ratios for 2-part products are described on the individual product data sheets and are given as a ratio by weight of each material.

What does "pot life" or "work life" mean?
The amount of time after a 2-part grade is mixed with its curing agent that it will remain useful or pliable.

How do I remove silicone?
Before it is cured: use a putty knife to remove any of the uncured paste. Wipe the area clean with isopropyl alcohol to remove any leftover residue. After it is cured: First mechanically remove as much of the silicone as you can with either a knife or a razor. A solvent (mineral spirits, toluene, xylene, acetone) can then be used to remove any oily residue or any remaining silicone. It may be necessary to soak the silicone in a solvent overnight to break it down.

Can I thin a silicone?
Silicone can be thinned using a solvent in which the silicone is miscible, generally an aromatic solvent such as toluene or xylene. As always, be sure to follow the producer's instructions when using solvent products and always use in a well-ventilated area. The shrinkage of the silicone and the cure time will increase with the addition of solvent. Alternative suggestions would include non-

reactive fluids or an RTV with a lower viscosity.

What can I do to improve the adhesion of the silicone adhesive to my parts?
The first step to good adhesion is to have clean surfaces for the silicone to bond to. For difficult-to-bond-substrates, Momentive Performance Materials offers a number of primers that can be used to improve and maximize adhesion.

How do I ensure that air is removed from 2-part grades?
If you are hand mixing, air may become added to the material during the mixing process. Vacuum de-airing is most effective in removing air prior to use. Automated mixing equipment that utilizes a static mixer can eliminate the need to de-air prior to dispensing.

On complex high-density electronics, air can sometimes be trapped under components during the potting process. Where this is a concern, potting under vacuum or vacuum de-airing after potting can remove the trapped air. An alternate approach may be to use a grade with a low viscosity and longer potlife and to cure at lower temperatures (if heat-cure grade), allowing entrapped air to escape prior to the cure of the material.

What is cure inhibition, and how do I prevent it?
Cure inhibition is a phenomenon that may be observed in addition-cure grades. These materials use a platinum catalyst to drive the curing reaction. Surfaces containing water, sulphur, nitrogen compounds, organic metal compounds, or phosphate compounds, may inhibit cure.

Cure inhibition is characterized by a gummy or sticky appearance of the silicone at the interface between the silicone and offending substrate. Inhibition can be prevented by application of a barrier coat, cleaning of the offending material prior to application of the silicone material, replacing the offending material with a suitable alternative, or selection of a condensation cure grade.

Dispensing Equipment Examples



Tube Type Dispensing Unit



Cartridge Air-Gun Dispensing Unit



Small Can Pump and Dispensing Unit



Cartridge Type Dispensing Unit



Pail Can Pump Unit

Customer Service Centers

Worldwide Hotline

T +1 800 295 2392 / +1 607 786 8131
F +1 607 786 8309

North America

cs-na.silicones@momentive.com

Silicones – Fluids, UA, Silianes, Specialty Coatings, RTV and Elastomers

T +1 800 523 5862 / +1 800 334 4674
F +1 304 746 1654 / +1 304 746 1623

Consumer Sealants/ Construction Sealants and Adhesives

T +1 877 943 7325
F +1 304 746 1654

Latin America

cs-la.silicones@momentive.com

South America

T +55 11 4534 9650
F +55 11 4534 9660

Mexico and Central America

T +52 55 2169 7670
F +52 55 2169 7699

Europe, Middle East, Africa and India

cs-eur.silicones@momentive.com

T +00 800 4321 1000 / +40 21 3111848

Pacific

cs-ap.silicones@momentive.com

China

T +800 820 0202 / +86 21 3860 4892

Japan

T +0120 975 400 / +81 276 20 6182
F +81 276 31 6259

Korea

T +82 2 6201 4600
F +82 2 6201 4601

Malaysia

T +60 3 9206 1555
F +60 3 9206 1533

Thailand

T +66 2207 3456
F +66 2207 3488

DISCLAIMER: THE MATERIALS, PRODUCTS AND SERVICES OF MOMENTIVE PERFORMANCE MATERIALS INC., MOMENTIVE PERFORMANCE MATERIALS USA INC., MOMENTIVE PERFORMANCE MATERIALS ASIA PACIFIC PTE. LTD., MOMENTIVE PERFORMANCE MATERIALS WORLDWIDE INC., MOMENTIVE PERFORMANCE MATERIALS GmbH, THEIR SUBSIDIARIES AND AFFILIATES DOING BUSINESS IN LOCAL JURISDICTIONS (collectively "SUPPLIERS"), ARE SOLD BY THE RESPECTIVE LEGAL ENTITY OF THE SUPPLIER SUBJECT TO SUPPLIERS' STANDARD CONDITIONS OF SALE, WHICH ARE INCLUDED IN THE APPLICABLE DISTRIBUTOR OR OTHER SALES AGREEMENT, PRINTED ON THE BACK OF ORDER ACKNOWLEDGMENTS AND INVOICES, AND AVAILABLE UPON REQUEST. ALTHOUGH ANY INFORMATION, RECOMMENDATIONS, OR ADVICE CONTAINED HEREIN IS GIVEN IN GOOD FAITH, SUPPLIERS MAKE NO WARRANTY OR GUARANTEE, EXPRESS OR IMPLIED, (i) THAT THE RESULTS DESCRIBED HEREIN WILL BE OBTAINED UNDER END-USE CONDITIONS, OR (ii) AS TO THE EFFECTIVENESS OR SAFETY OF ANY DESIGN INCORPORATING SUPPLIERS' PRODUCTS, MATERIALS, SERVICES, RECOMMENDATIONS OR ADVICE. AFOREMENTIONED EXCLUSIONS OR LIMITATION OF LIABILITY ARE NOT APPLICABLE TO THE EXTENT THAT THE END-USE CONDITIONS AND/OR INCORPORATION CONDITIONS CORRESPOND TO THE RECOMMENDED CONDITIONS OF USE AND/OR OF INCORPORATION AS DESCRIBED BY SUPPLIER IN ITS PRODUCT DATA SHEET AND/OR PRODUCT SPECIFICATIONS. EXCEPT AS PROVIDED IN SUPPLIERS' STANDARD CONDITIONS OF SALE, SUPPLIERS AND THEIR REPRESENTATIVES SHALL IN NO EVENT BE RESPONSIBLE FOR ANY LOSS RESULTING FROM ANY USE OF ITS MATERIALS, PRODUCTS OR SERVICES DESCRIBED HEREIN. Each user bears full responsibility for making its own determination as to the suitability of Suppliers' materials, services, recommendations, or advice for its own particular use. Each user must identify and perform all tests and analyses necessary to assure that its finished parts incorporating Suppliers' products, materials, or services will be safe and suitable for use under end-use conditions. Nothing in this or any other document, nor any oral recommendation or advice, shall be deemed to alter, vary, supersede, or waive any provision of Suppliers' Standard Conditions of Sale or this Disclaimer, unless any such modification is specifically agreed to in a writing signed by Suppliers. No statement contained herein concerning a possible or suggested use of any material, product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right of Suppliers or any of its subsidiaries or affiliates covering such use or design, or as a recommendation for the use of such material, product, service or design in the infringement of any patent or other intellectual property right.

Technical subject matter in this publication is described and protected by one or more of the following U.S. Patents and their foreign counterpart patents and/or patent applications: U.S. Patent Nos. 7,411,007; 7,388,049; 7,387,784; 7,381,769; 7,374,771; 7,241,835; 7,217,777; 6,759,479; 6,538,061; 6,531,540; 6,475,568; 6,444,745; 6,291,563; 6,207,782; 5,981,681; and 5,807,956. Other U.S. and foreign patents and/or patent applications not listed covering the subject matter may be relevant.

*SilCool and InvisiSil are trademarks of Momentive Performance Materials Inc.
The Momentive logo is a trademark of Momentive Performance Materials Holdings LLC.



22 Corporate Woods Boulevard
Albany, NY 12211 USA

+1 800 295 2392
+1 607 786 8131
momentive.com